

N and P-Channel Enhancement Mode Power MOSFET



The NCE30NP1812K uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

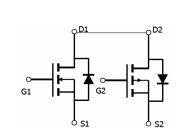
N-Channel

 $V_{DS} = 30V, I_D = 18A$ $R_{DS(ON)} < 41m\Omega @ V_{GS} = 10V$ $R_{DS(ON)} < 54m\Omega @ V_{GS} = 4.5V$

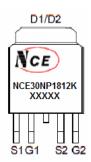
• P-Channel

$$\begin{split} V_{DS} =& -30 V, I_D = -12 A \\ R_{DS(ON)} <& 58 m \Omega @ V_{GS} =& -10 V \\ R_{DS(ON)} <& 85 m \Omega @ V_{GS} =& -4.5 V \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Schematic diagram



Marking and pin assignment

100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30NP1812K	NCE30NP1812K	TO-252-4L	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V _{DS}	30	-30	V	
Gate-Source Voltage		V _{GS}	±12	±12	V	
	T _A =25℃		18	-12	•	
Continuous Drain Current	T _A =70℃	ID	14.4	-8.5	A	
Pulsed Drain Current (Note 1)		I _{DM}	72	-48	А	
Maximum Power Dissipation	T _A =25℃	PD	25	25	W	
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note2)	R _{ejc}	N-Ch	5	°C/W
Thermal Resistance, Junction-to-Case ^(Note2)	$R_{ extsf{ heta}JC}$	P-Ch	5	°C/W



N-CH Electrical Characteristics (T_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
\Off Characteristics	·····			•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.5	2.0	V
Durain Courses On State Desistance	P	V_{GS} =10V, I_{D} =10A	-	36	41	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	45	54	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =10A		10	-	S
Dynamic Characteristics (Note4)	·			•		
Input Capacitance	C _{lss}		-	519.9	-	PF
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	55.5	-	PF
Reverse Transfer Capacitance	C _{rss}		-	49.3	-	PF
Switching Characteristics (Note 4)	·			•		
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V_{DD} =15V, R _L =1.5 Ω	-	3	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	15	-	nS
Turn-Off Fall Time	t _f		-	3	-	nS
Total Gate Charge	Qg		-	14.7	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =10A,	-	2.5	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	3.0	_	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-	0.8	1.2	V



P-CH Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =-30V, V_{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.0	-1.5	-2.0	V
Desia Oscara Os Otata Dasistanas		V _{GS} =-10V, I _D =-12A	-	50	58	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =-4.5V, I _D =-10A	-	71	85	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-12A	-	10	-	S
Dynamic Characteristics (Note4)			1			
Input Capacitance	C _{lss}		-	464.7	-	PF
Output Capacitance	C _{oss}	V _{DS} =-15V,V _{GS} =0V, F=1.0MHz	-	70.4	-	PF
Reverse Transfer Capacitance	C _{rss}		-	53.8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	t _r	V_{DD} =-15V, R _L =1.25 Ω	-	3	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	15	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg		-	12.6	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-12A V _{GS} =-10V	-	2.1	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	3.0	-	nC
Drain-Source Diode Characteristics	I					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-12A	-	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

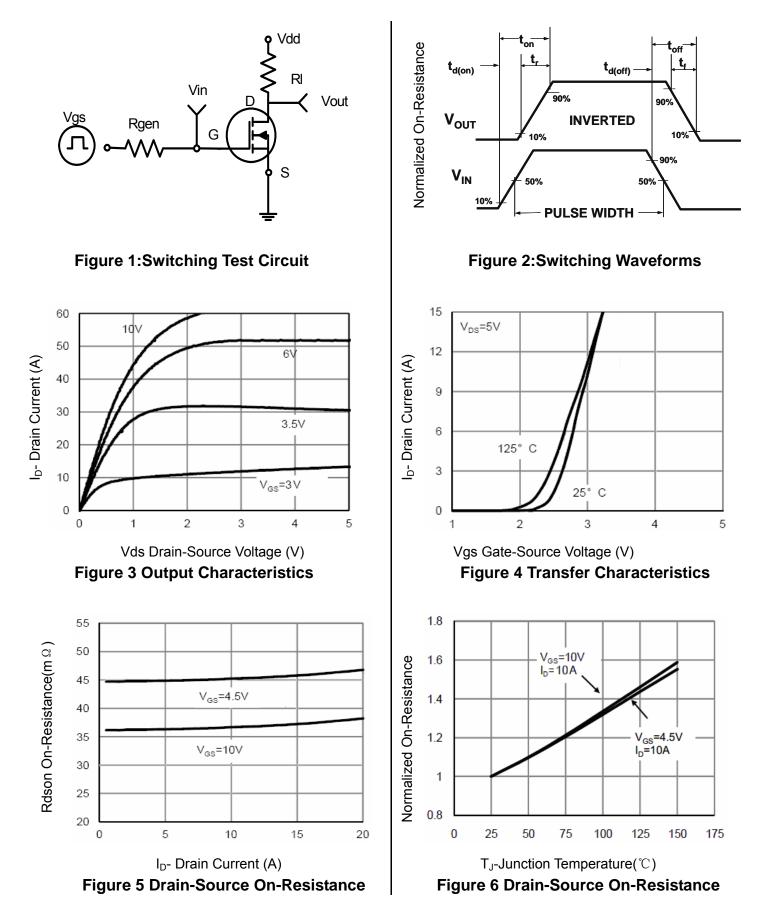
2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

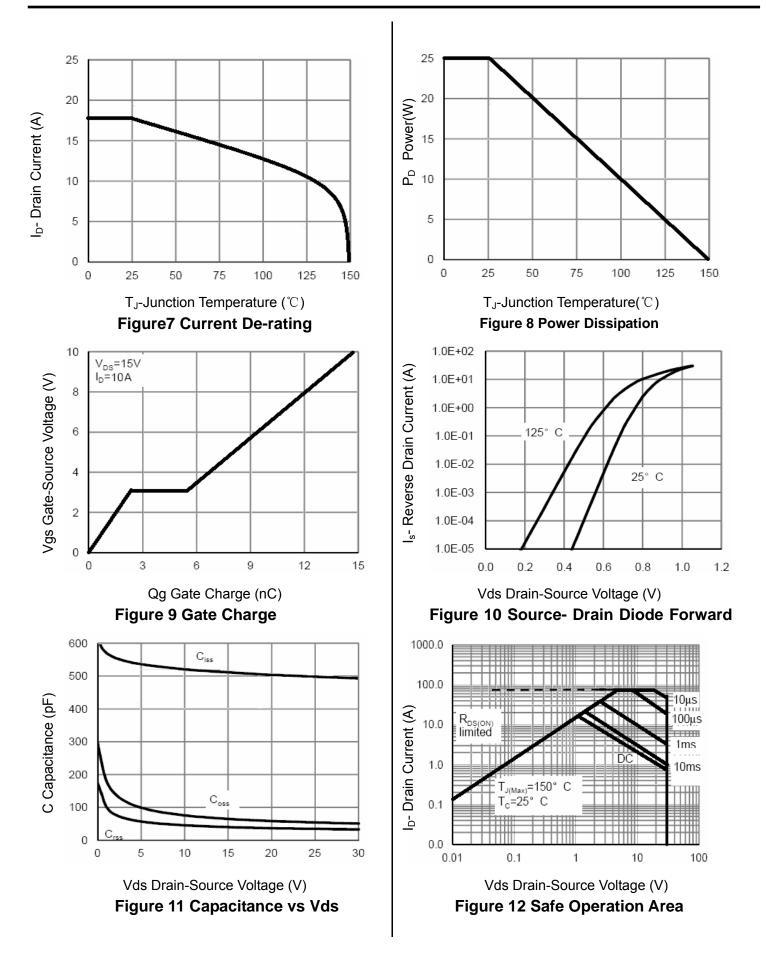


N- Channel Typical Electrical and Thermal Characteristics (Curves)





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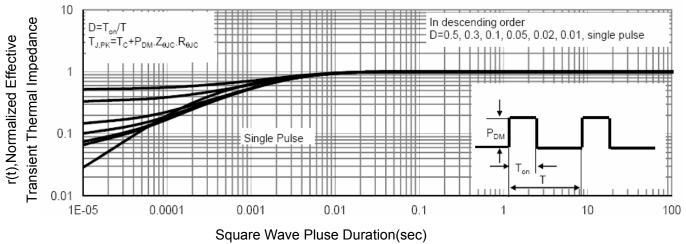
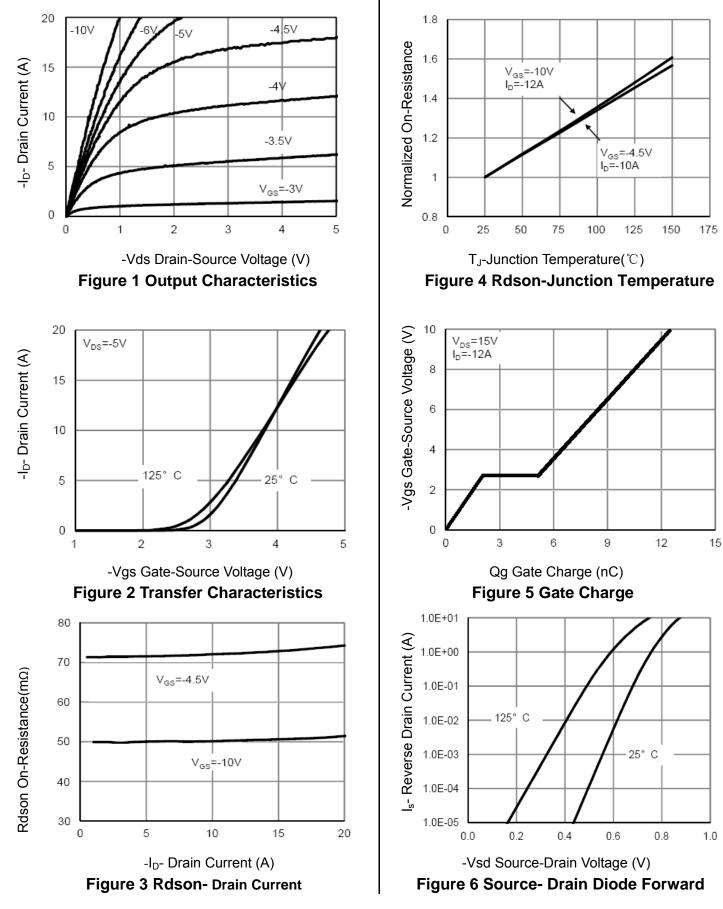


Figure 13 Normalized Maximum Transient Thermal Impedance

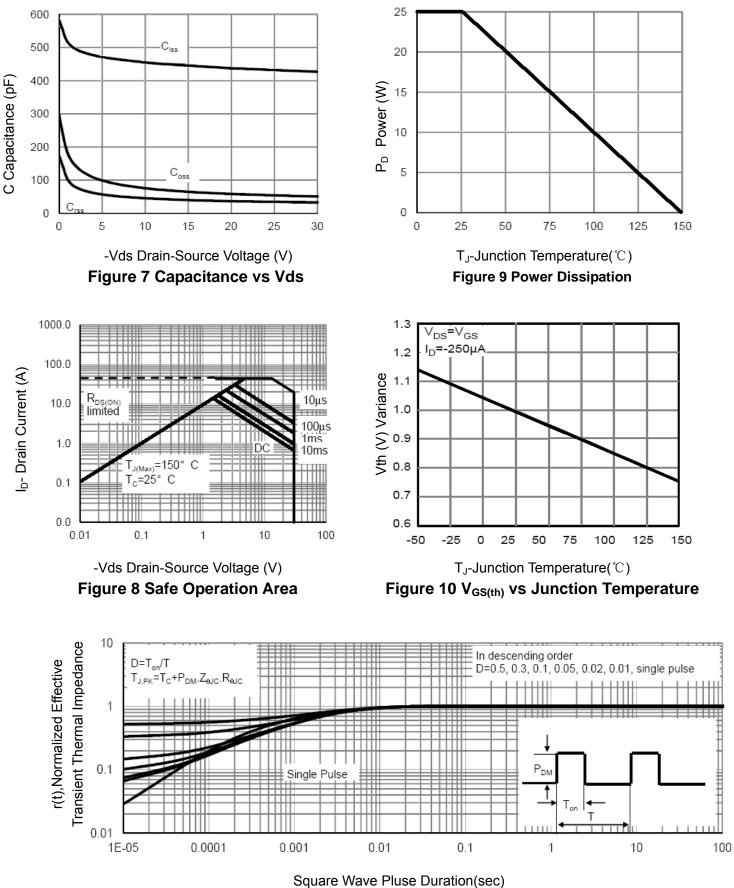


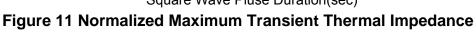
P- Channel Typical Electrical and Thermal Characteristics (Curves)





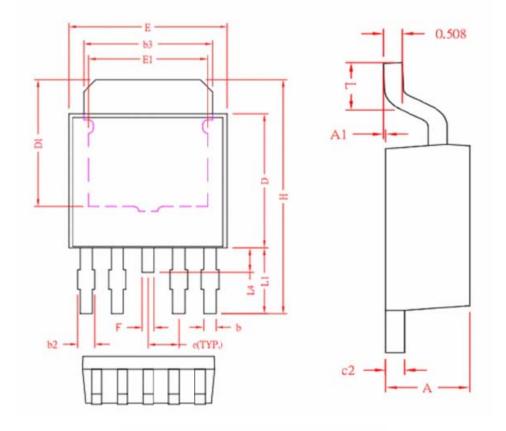
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TO-252-4L Package Information



(UNITS	OF MEAS	URE=MILL	IMETER)		
SYMBOL	MIN	NOM	MAX		
A	2.20	2.30	2.40		
A1	0	0.08	0.15		
b	0.45	0.53	0.60		
b2	0.50	0.65	0.80		
b3	5.20	5.35	5.50		
c2	0.45	0.50	0.55		
D	5.40	5.60	5.80		
D1	4.57		-		
E	6.40	6.60	6.80		
E1	3.81	-			
е	1.27 REF.				
F	0.40	0.50	0.60		
H	9.40	9.80	10.20		
L	1.40	1.59	1.77		
L1	2.40	2.70	3.00		
L4	0.80	1.00	1.20		

COMMON DIMENSIONS



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